TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

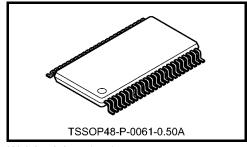
# **TC74LCX16245FT**

#### Low-Voltage 16-Bit Bus Transceiver with 5-V Tolerant Inputs and Outputs

The TC74LCX16245FT is a high-performance CMOS 16-bit bus transceiver. Designed for use in 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (2.5-V or 3.3-V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 16-bit bus transceiver is controlled by direction control (DIR) inputs and output enable ( $\overline{OE}$ ) inputs which are common to each byte. It can be used as two 8-bit transceiver or one 16-bit transceiver. The direction of data transmission is determined by the level of the DIR inputs. The  $\overline{OE}$  inputs can be used to disable the device so that the busses are effectively isolated.



Weight: 0.25 g (typ.)

All inputs are equipped with protection circuits against static discharge.

#### Features (Note)

- Low-voltage operation:  $V_{CC} = 2.0$  to 3.6 V
- High-speed operation:  $t_{pd} = 4.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Ouput current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- · Package: TSSOP
- Bidirectional interface between 5.0 V and low-voltage (2.5-V or 3.3-V) signals
- · Power-down protection provided on all inputs and outputs

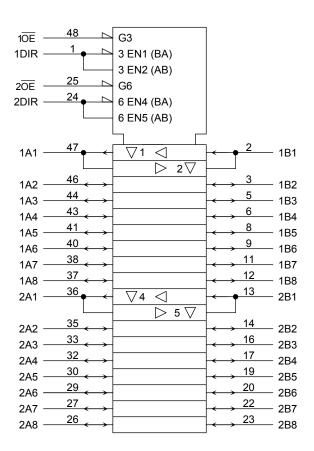
Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input level fixed by means of pull-up or pull-down resistors.

#### Pin Assignment (top view)

#### 1DIR 48 10E 1B1 2 47 1A1 3 1B2 1A2 46 GND 4 **GND** 45 5 1B3 1A3 1B4 6 43 1A4 $V_{CC}$ 7 $V_{CC}$ 42 1B5 8 41 1A5 1B6 9 1A6 40 GND 10 **GND** 39 1B7 11 38 1A7 1B8 12 37 1A8 2B1 13 36 2A1 2B2 14 35 2A2 GND 15 GND 34 2B3 16 33 2A3 2B4 17 32 2A4 V<sub>CC</sub> 18 31 $V_{CC}$ 2B5 19 2A5 30 2B6 20 29 2A6 GND 21 28 **GND** 2B7 22 27 2A7 2B8 23 26 2A8 2DIR 24 2OE 25

## **IEC Logic Symbol**



## **Truth Table**

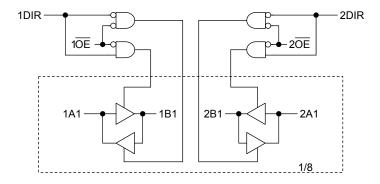
Inputs		Function		
1 <del>OE</del>	1DIR	Bus Bus 1A1-1A8 1B1-1B8		Outputs
L	L	Output Input		A = B
L	Н	Input Output		B=A
Н	Х	Z		Z

Inputs		Function		
2 <del>OE</del>	2DIR	Bus Bus 2A1-2A8 2B1-2B8		Outputs
L	L	Output Input		A = B
L	Н	Input Output		B=A
Н	Х	Z		Z

X: Don't care

Z: High impedance

# **System Diagram**



# **Absolute Maximum Ratings (Note 1)**

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Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	-0.5 to 6.0	V	
DC input voltage (DIR, $\overline{OE}$ )	V <sub>IN</sub>	-0.5 to 7.0	٧	
DC bus I/O voltage	Viva	-0.5 to 7.0 (Note 2)	V	
DC bus I/O voltage	V <sub>I/O</sub>	$-0.5 \text{ to V}_{CC} + 0.5 \text{ (Note 3)}$	V	
Input diode current	l <sub>IK</sub>	-50	mA	
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA	
DC output current	lout	±50	mA	
Power dissipation	$P_{D}$	400	mW	
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature	T <sub>stg</sub>	-65 to 150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

#### Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	V	
Tower supply voltage	VCC	1.5 to 3.6 (Note 2)	V	
Input voltage (DIR, $\overline{OE}$ )	V <sub>IN</sub>	0 to 5.5	٧	
Bus I/O voltage	V <sub>I/O</sub>	0 to 5.5 (Note 3)	V	
Bus I/O voltage	V 1/O	0 to V <sub>CC</sub> (Note 4)	\ \ \	
		±24 (Note 5)		
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 6)	mA	
		±8 (Note 7)		
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 8:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



## **Electrical Characteristics**

# DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics		Symbol	ol Test Condition			Min	Max	Unit
		- Cymbol Test condition		Sildition	V <sub>CC</sub> (V)	IVIIII	Max	Orme
11	H-level	\/			2.3 to 2.7	1.7	_	
Input voltage	n-level	V <sub>IH</sub>	_	_	2.7 to 3.6	2.0	_	V
Input voltage	L-level	V.,			2.3 to 2.7	_	0.7	V
	L-ievei	V <sub>IL</sub>	_		2.7 to 3.6	_	0.8	
				$I_{OH} = -100 \mu A$	2.3 to 3.6	V <sub>CC</sub> - 0.2		
				$I_{OH} = -8 \text{ mA}$	2.3	1.8		
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -12 \text{ mA}$	2.7	2.2		V
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2		
			$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 100 \ \mu A$	2.3 to 3.6		0.2	
				$I_{OL} = 8 \text{ mA}$	2.3		0.6	
	L-level	V <sub>OL</sub>		$I_{OL} = 12 \text{ mA}$	2.7		0.4	
				$I_{OL} = 16 \text{ mA}$	3.0		0.4	
				$I_{OL} = 24 \text{ mA}$	3.0		0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.3 to 3.6		±5.0	μΑ
3-state output OFF sta	output OFF state current $I_{OZ}$ $V_{IN} = V_{IH}$ or $V_{IL}$			2.3 to 3.6		±5.0	μА	
3-state output OFF state current		102	V <sub>OUT</sub> = 0 to 5.5 V		2.5 to 5.0		±3.0	μΛ
Power-off leakage current		l <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА
Quiescent supply curre	Quiescent supply current		$V_{IN} = V_{CC}$ or GND		2.3 to 3.6	_	20.0	
Quiescent supply curre			V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.3 to 3.6		±20.0	μΑ
Increase in Icc per inp	ut	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.3 to 3.6		500	

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#### AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	/mbol Test Condition				Max	Unit
Characteristics	Syllibol	rest Condition	V <sub>CC</sub> (V)	CL(pF)	Min	IVIAX	Offic
	+		$2.5 \pm 0.2$	30	1.5	5.4	
Propagation delay time	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	2.7	50	1.5	5.2	ns
	чрнц		$3.3\pm0.3$	50	1.5	4.5	
	+		$2.5\pm0.2$	30	1.5	8.5	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7	50	1.5	7.2	ns
			$3.3 \pm 0.3$	50	1.5	6.5	
	4		$2.5\pm0.2$	30	1.5	7.7	
3-state output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7	50	1.5	6.9	ns
			$3.3\pm0.3$	50	1.5	6.0	
Output to output skew	t <sub>osLH</sub>		$2.5\pm0.2$	30			
		(Note)	2.7	50			ns
		;HL	3.3 ± 0.3	50	_	1.0	

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, \, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

# Dynamic Switching Characteristics

(Ta = 25°C, input:  $t_r = t_f = 2.5$  ns,  $R_L = 500$  Ω)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum	V <sub>OLP</sub>	V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =30pF	2.5	0.6	V
dynamic V <sub>OL</sub>	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 50 \text{pF}$	3.3	8.0	•
Quiet output minimum	IVd	V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =30pF	2.5	0.6	V
dynamic V <sub>OL</sub>	Volv	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =50pF	3.3	0.8	V

# **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Bus input capacitance	C <sub>I/O</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (Not	e) 3.3	25	pF

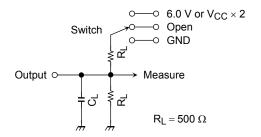
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>			
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

#### **AC Waveform**

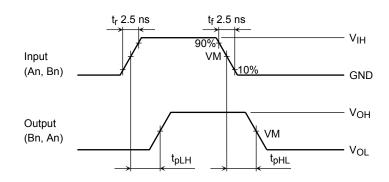


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

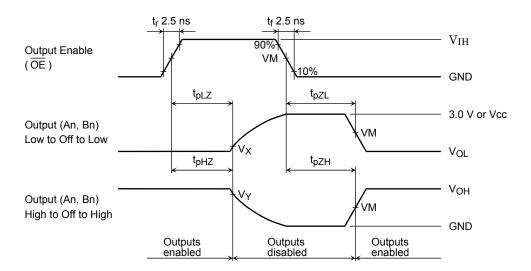
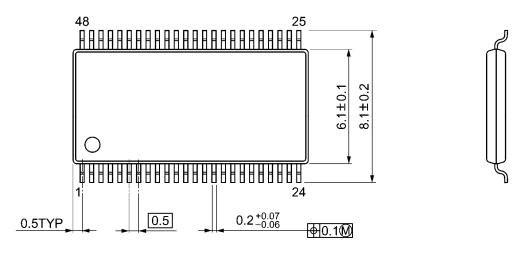


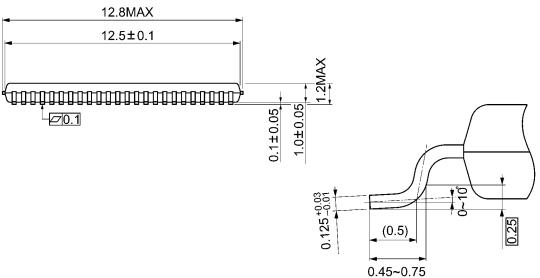
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

Symbol		V <sub>CC</sub>	
Symbol	$3.3\pm0.3~\textrm{V}$	2.7 V	$2.5\pm0.2\textrm{V}$
V <sub>IH</sub>	2.7 V	2.7 V	V <sub>CC</sub>
V <sub>M</sub>	1.5 V	1.5 V	V <sub>CC</sub> /2
VX	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V

## **Package Dimensions**

TSSOP48-P-0061-0.50A Unit: mm





Weight: 0.25 g (typ.)

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